

Silicon Diffused Power Transistor

BU2520AW

GENERAL DESCRIPTION

New generation, high-voltage, high-speed switching npn transistor in a plastic envelope intended for use in horizontal deflection circuits of large screen colour television receivers up to 32 kHz.

QUICK REFERENCE DATA

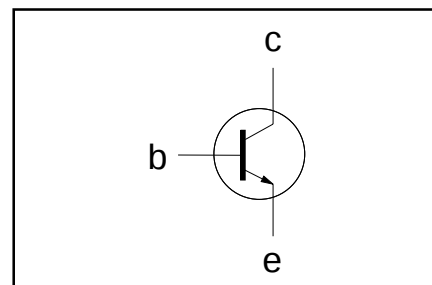
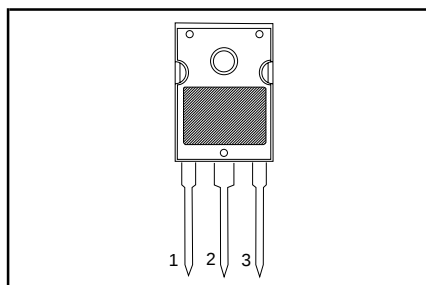
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_C	Collector current (DC)		-	10	A
I_{CM}	Collector current peak value		-	25	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25\text{ °C}$	-	125	W
V_{CESat}	Collector-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.2\text{ A}$	-	5.0	V
I_{Csat}	Collector saturation current		6	-	A
t_f	Fall time	$I_{Csat} = 6.0\text{ A}; I_{B(end)} = 0.85\text{ A}$	0.2	0.35	μs

PINNING - SOT429

PIN CONFIGURATION

SYMBOL

PIN	DESCRIPTION
1	base
2	collector
3	emitter
tab	collector



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CESM}	Collector-emitter voltage peak value	$V_{BE} = 0\text{ V}$	-	1500	V
V_{CEO}	Collector-emitter voltage (open base)		-	800	V
I_C	Collector current (DC)		-	10	A
I_{CM}	Collector current peak value		-	25	A
I_B	Base current (DC)		-	6	A
I_{BM}	Base current peak value		-	9	A
$-I_{B(AV)}$	Reverse base current	average over any 20 ms period	-	150	mA
$-I_{BM}$	Reverse base current peak value ¹		-	6	A
P_{tot}	Total power dissipation	$T_{mb} \leq 25\text{ °C}$	-	125	W
T_{stg}	Storage temperature		-65	150	°C
T_j	Junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Junction to mounting base	-	-	1.0	K/W
$R_{th\ j-a}$	Junction to ambient	in free air	45	-	K/W

¹ Turn-off current.

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STATIC CHARACTERISTICS

 $T_{mb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CES}	Collector cut-off current ²	$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$	-	-	1.0	mA
I_{CES}		$V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$ $T_J = 125\text{ }^{\circ}\text{C}$	-	-	2.0	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 7.5\text{ V}; I_C = 0\text{ A}$	-	-	1.0	mA
BV_{EBO}	Emitter-base breakdown voltage	$I_B = 1\text{ mA}$	7.5	13.5	-	V
$V_{CEOsust}$	Collector-emitter sustaining voltage	$I_B = 0\text{ A}; I_C = 100\text{ mA};$ $L = 25\text{ mH}$	800	-	-	V
V_{CEsat}	Collector-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.2\text{ A}$	-	-	5.0	V
V_{BEsat}	Base-emitter saturation voltage	$I_C = 6.0\text{ A}; I_B = 1.2\text{ A}$	-	-	1.1	V
h_{FE}	DC current gain	$I_C = 100\text{ mA}; V_{CE} = 5\text{ V}$	-	13	-	
h_{FE}		$I_C = 6\text{ A}; V_{CE} = 5\text{ V}$	5	7	9.5	

DYNAMIC CHARACTERISTICS

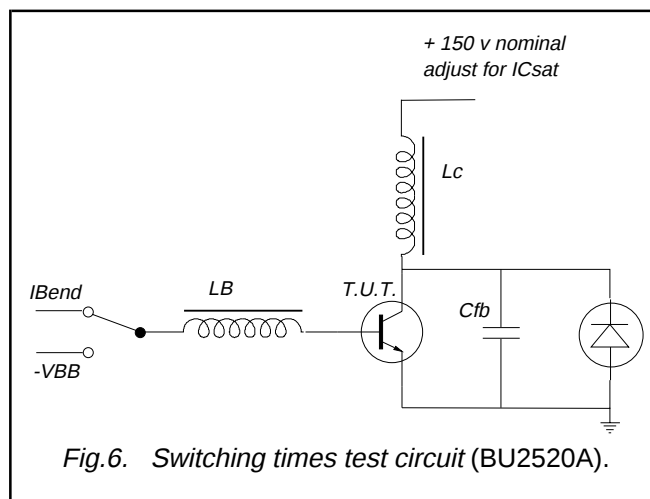
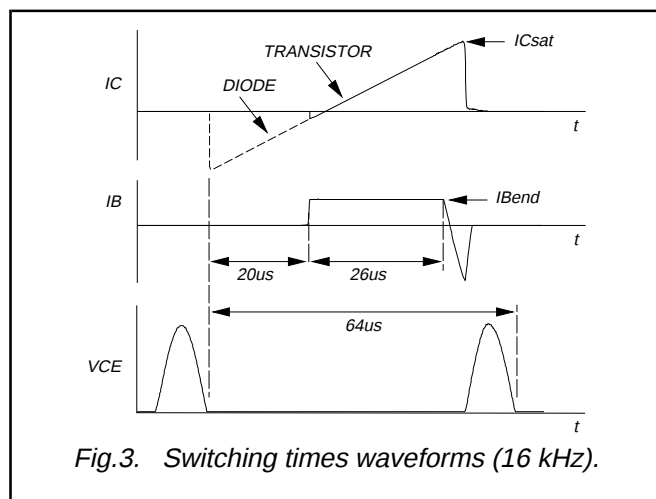
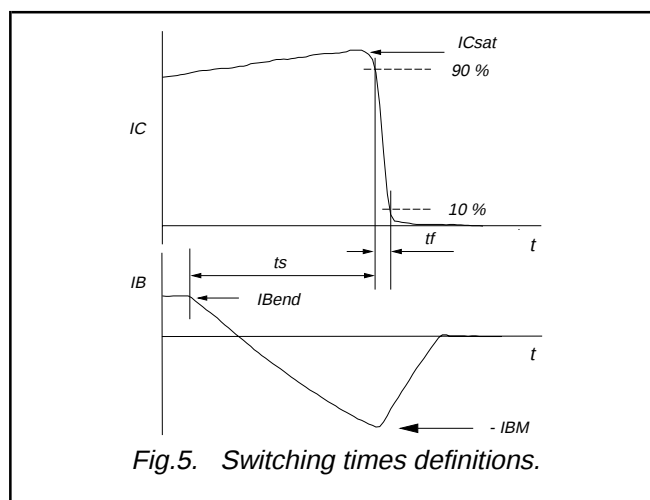
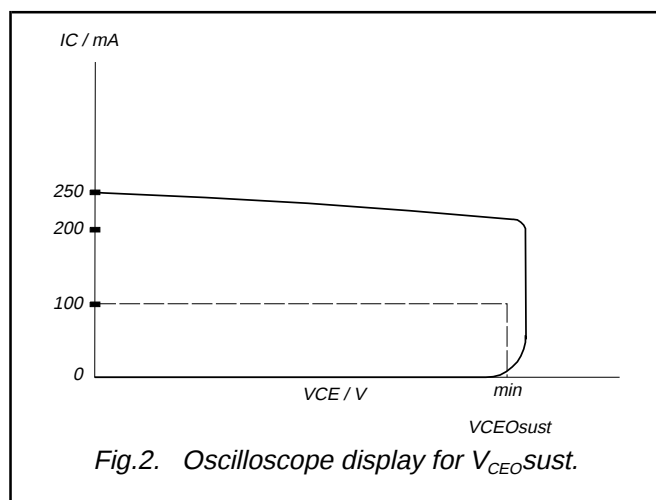
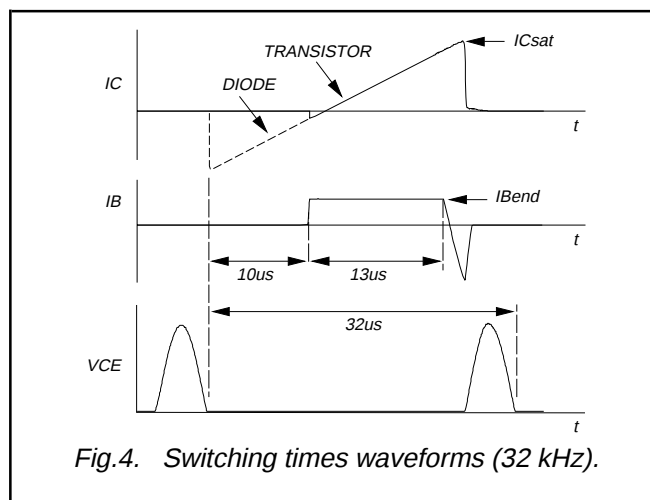
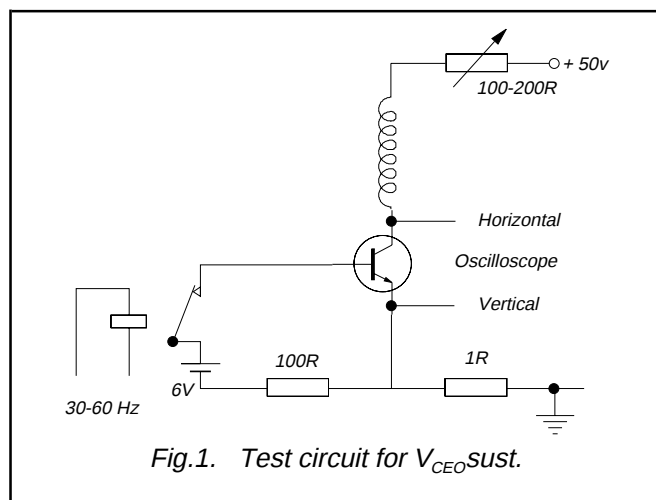
 $T_{mb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
C_c	Collector capacitance	$I_E = 0\text{ A}; V_{CB} = 10\text{ V}; f = 1\text{ MHz}$	115	-	pF
	Switching times (32 kHz line deflection circuit)	$I_{Csat} = 6.0\text{ A}; L_C = 330\text{ }\mu\text{H}; C_{fb} = 9\text{ nF};$ $I_{B(end)} = 0.85\text{ A}; L_B = 3.45\text{ }\mu\text{H};$ $-V_{BB} = 4\text{ V}; (-dI_B/dt = 1.2\text{ A}/\mu\text{s})$			
t_s	Turn-off storage time		3.0	4.0	μs
t_f	Turn-off fall time		0.2	0.35	μs
	Switching times (16 kHz line deflection circuit)	$I_{Csat} = 6.0\text{ A}; L_C = 650\text{ }\mu\text{H}; C_{fb} = 19\text{ nF};$ $I_{B(end)} = 1.0\text{ A}; L_B = 5.3\text{ }\mu\text{H}; -V_{BB} = 4\text{ V};$ $(-dI_B/dt = 0.8\text{ A}/\mu\text{s})$			
t_s	Turn-off storage time		4.5	5.5	μs
t_f	Turn-off fall time		0.35	0.5	μs

2 Measured with half sine-wave voltage (curve tracer).

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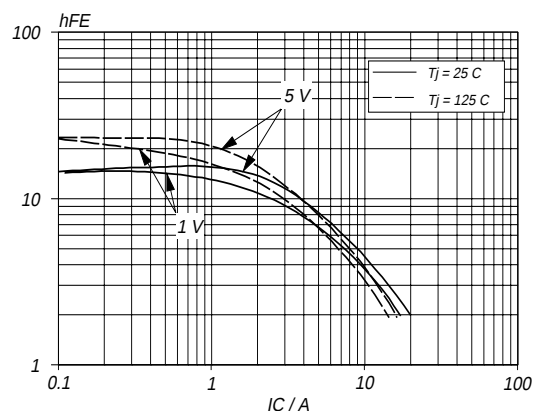


Fig. 7. Typical DC current gain. $h_{FE} = f(I_C)$
parameter V_{CE}

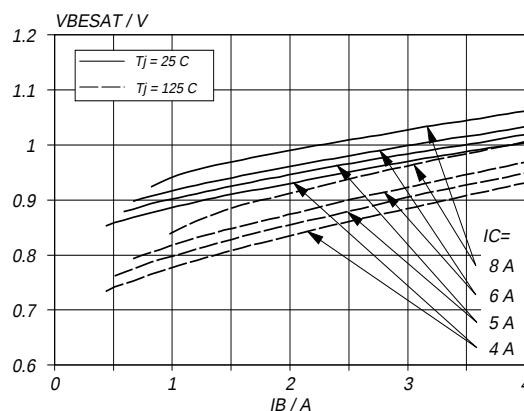


Fig. 10. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_B)$; parameter I_C

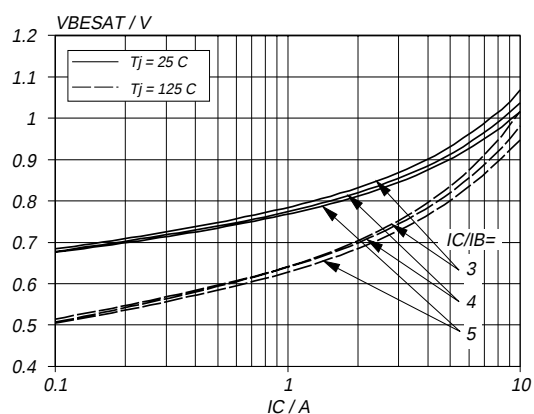


Fig. 8. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_C)$; parameter I_C/I_B

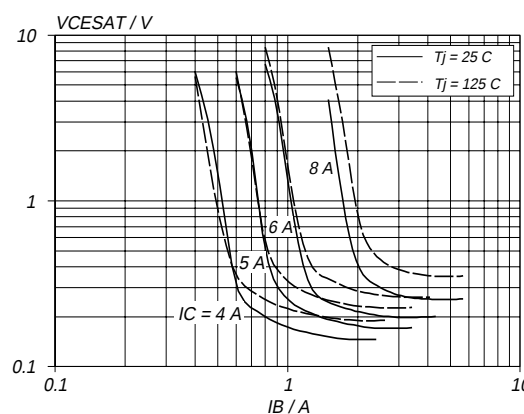


Fig. 11. Typical collector-emitter saturation voltage.
 $V_{CEsat} = f(I_B)$; parameter I_C

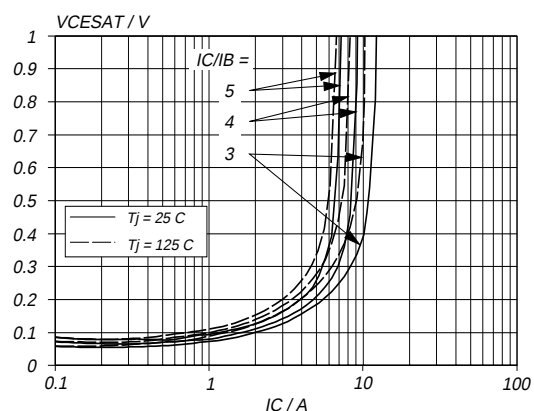


Fig. 9. Typical collector-emitter saturation voltage.
 $V_{CEsat} = f(I_C)$; parameter I_C/I_B

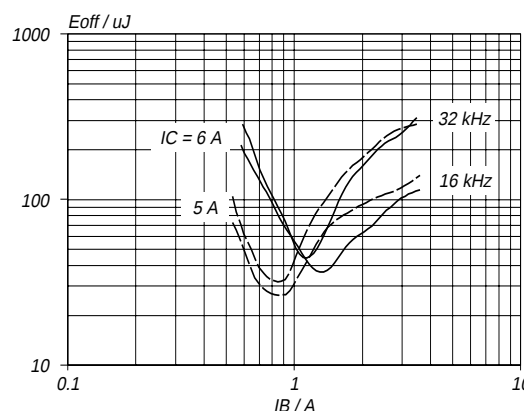


Fig. 12. Typical turn-off losses. $T_J = 85^\circ\text{C}$
 $E_{off} = f(I_B)$; parameter I_C ; parameter frequency

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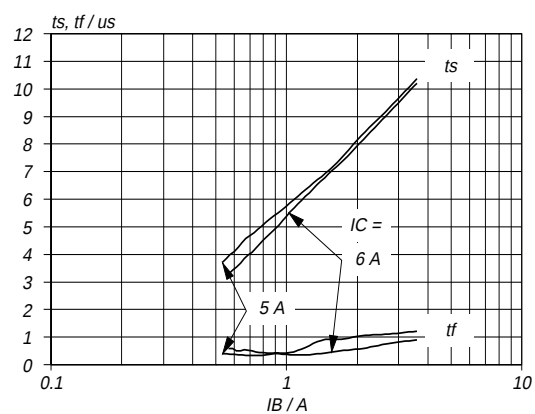


Fig.13. Typical collector storage and fall time.
 $t_s = f(I_B)$; $t_f = f(I_B)$; parameter I_C ; $T_j = 85^\circ\text{C}$; $f = 16\text{ kHz}$

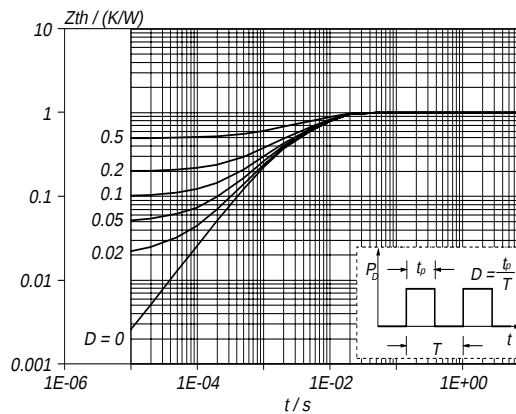


Fig.16. Transient thermal impedance.
 $Z_{th\ j-mb} = f(t)$; parameter $D = t_p/T$

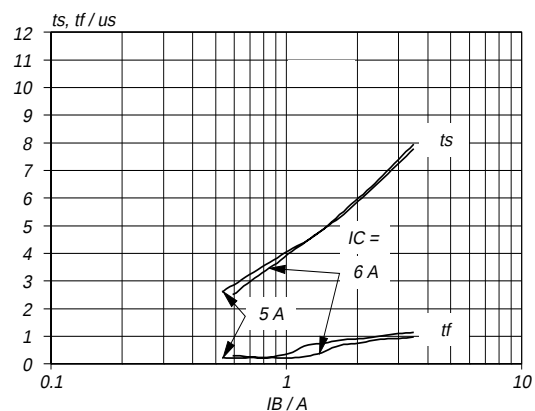


Fig.14. Typical collector storage and fall time.
 $t_s = f(I_B)$; $t_f = f(I_B)$; parameter I_C ; $T_j = 85^\circ\text{C}$; $f = 32\text{ kHz}$

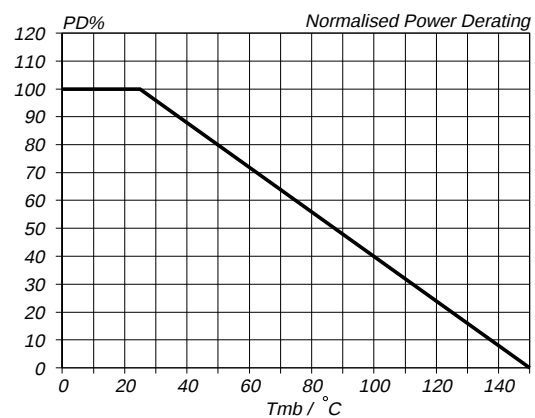


Fig.15. Normalised power dissipation.
 $PD\% = 100 \cdot P_D / P_{D\ 25^\circ\text{C}} = f(T_{mb})$

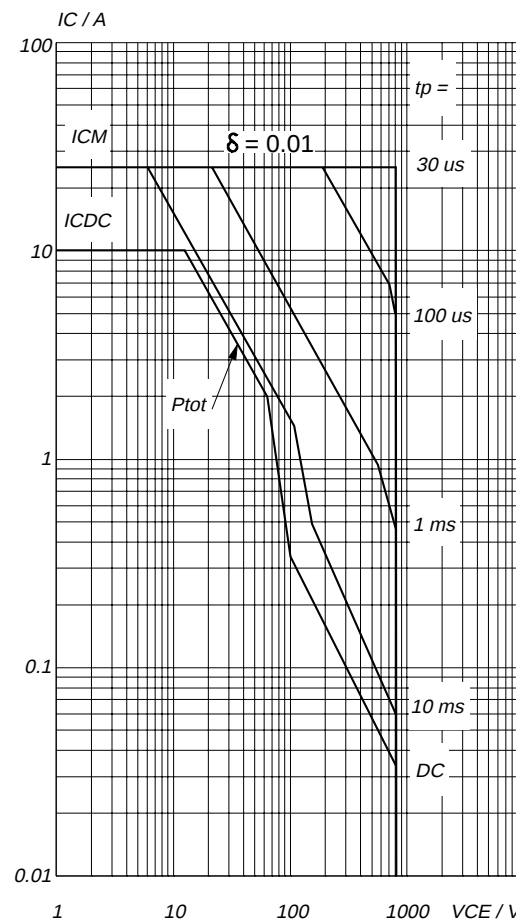
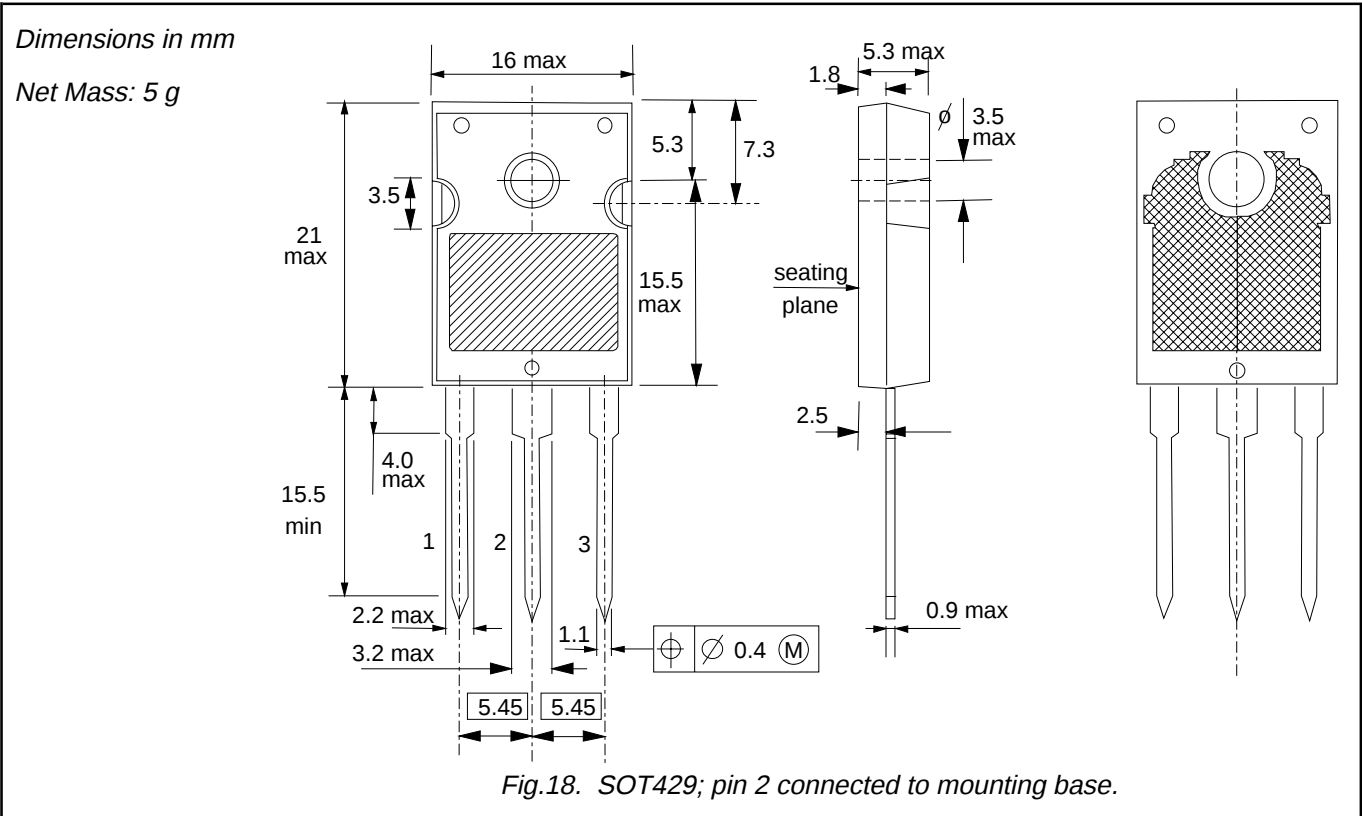


Fig.17. Forward bias safe operating area. $T_{mb} = 25^\circ\text{C}$
 I_{CDC} & $I_{CM} = f(V_{CE})$; I_{CM} single pulse; parameter t_p
 Second-breakdown limits independent of temperature.

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MECHANICAL DATA

**Notes**

1. Refer to mounting instructions for SOT429 envelope.
2. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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